

Figure 1: Corner Gate Mold Option, FG484/FGG484 Package

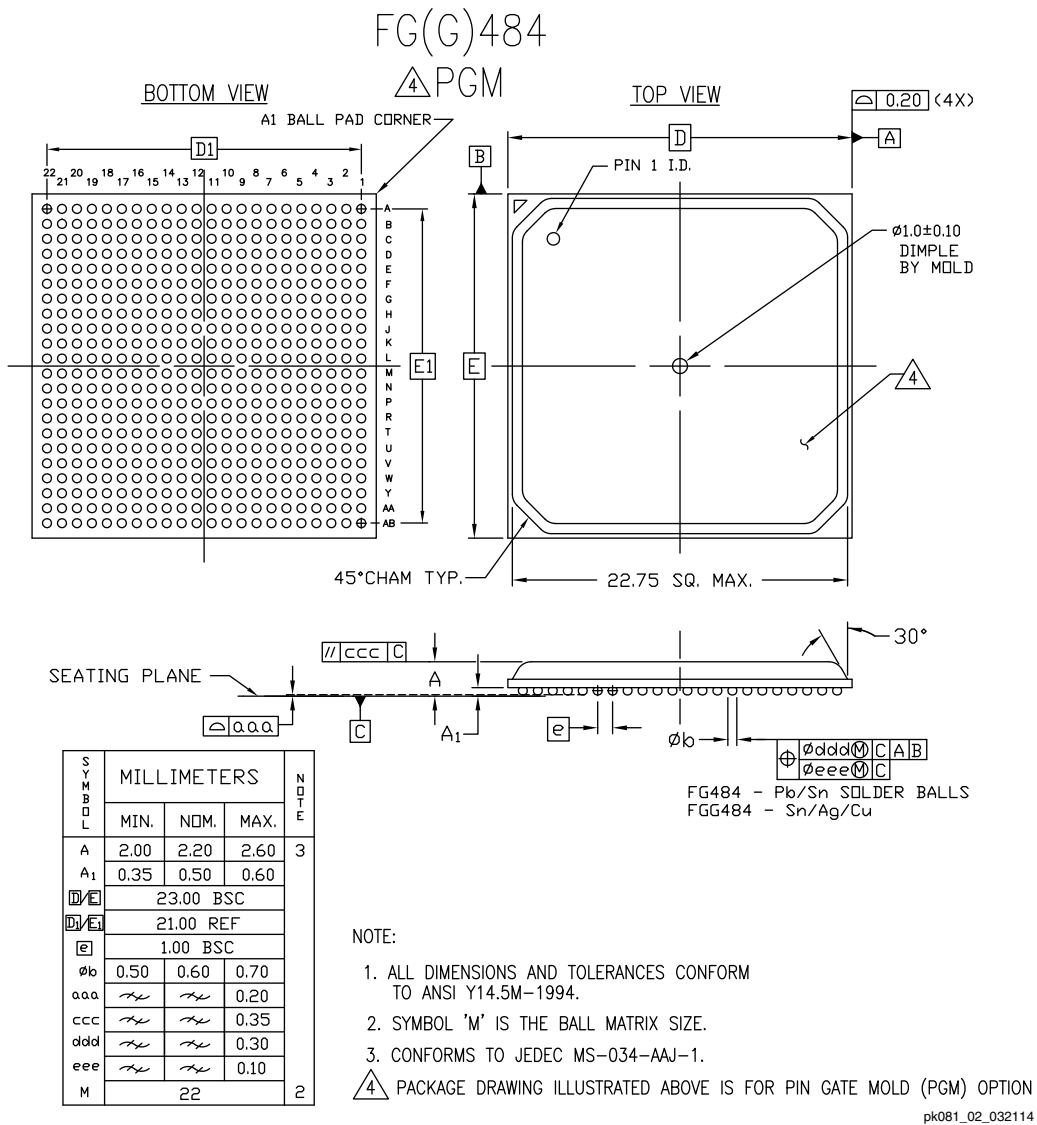


Figure 2: Pin Gate Mold Option, FG484/FGG484 Package

## Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
03/01/2005	1.0	Initial Xilinx release.
12/15/2008	1.1	Added "a" min. 2.00 and max. 2.20 on the dimension table and updated the notes section.
04/04/2014	1.2	Added <a href="#">Figure 2</a> , pin gate mold package as described in <a href="#">XCN12023</a> .

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